## 1206 Slow Blow SMD Fuses



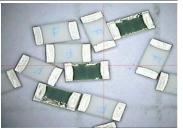






#### Description

12S Series are the fuses set the industry standard for performance, reliability and quality. The solder-free design provides excellent on-off and temperature cycling characteristics during use and also makes our SMD fuses more heat and shock tolerant than typical subminiature fuses.



	Electrical Characteristics					
Rated Current	1.0ln	2.5ln	3.0ln	3.5ln	10.0ln	
4.5A~5A	4 hour min.	5 sec max.	0.1sec - 3sec	-	0.2ms - 20ms	
6A~30A	4 hour min.	-	-	5 sec max.	0.2ms - 10ms	

#### **Features**

- High inrush current withstanding capability
- AEC-Q200 Automotive Grade Certified
- > Compatible with reflow and wave solder
- Ceramic and glass construction
- > Excellent environmental integrity
- One time positive disconnect
- Lead Free and Halogen free material

#### **Specifications**

Specification								
Part No.	Rated		Rated Current	Breaking Capacity (A) <sup>1</sup>	Typical Cold. Resistance (mOhms) <sup>2</sup>	Typical Voltage Drop (mV)	Typical Pre- Arcing I <sup>2</sup> t (A <sup>2</sup> Sec) <sup>3</sup>	Alpha Mark
	Voltage		(4)					
	DC		(A)					
12S1450	72V	32V	4.5	50A	27	164	2.65	Χ
12S1500	63V		5	50A	22	145	4	Т
12S1600	72V	32V	6	50A	14.5	140	12	F
12S1700	63V		7	50A	10.5	130	14	7
12S1800		32V	8	150A	7.0	123	16	V
12S2100			10	150A	5.0	110	22	U
12S2120	48V		12	150A	3.7	80	40	W
12S2150			15	150A	3.0	85	45	Υ
12S2200			20	150A	2.0	80	50	Q
12S2250	36V	32V	25	150	1.55	90	58	L
12S2300	30 V	3∠V	30	150	1.32	90	95	Z

- 1. DC Interrupting Rating (Measured at rated voltage, time constant of less than 50 microseconds, battery source)
- 2. DC Cold Resistance are measured at <10% of rated current in ambient temperature of 25°C
- 3. Typical Pre-arcing I<sup>2</sup>t are measured at 10In Current

Choice fuse for surge application (USB charger etc.), make sure the I<sup>2</sup>t of fuse is 4 times than surge. Specifications are subject to change without notice. Application testing is strongly recommended.





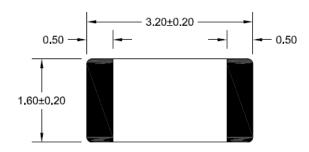




#### **Dimension**

Drawing not to scale (Unit: mm)

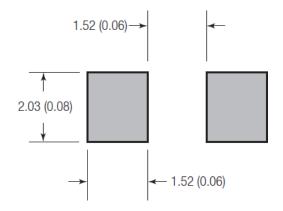
# Top view



Side view



# **Recommended land pattern**



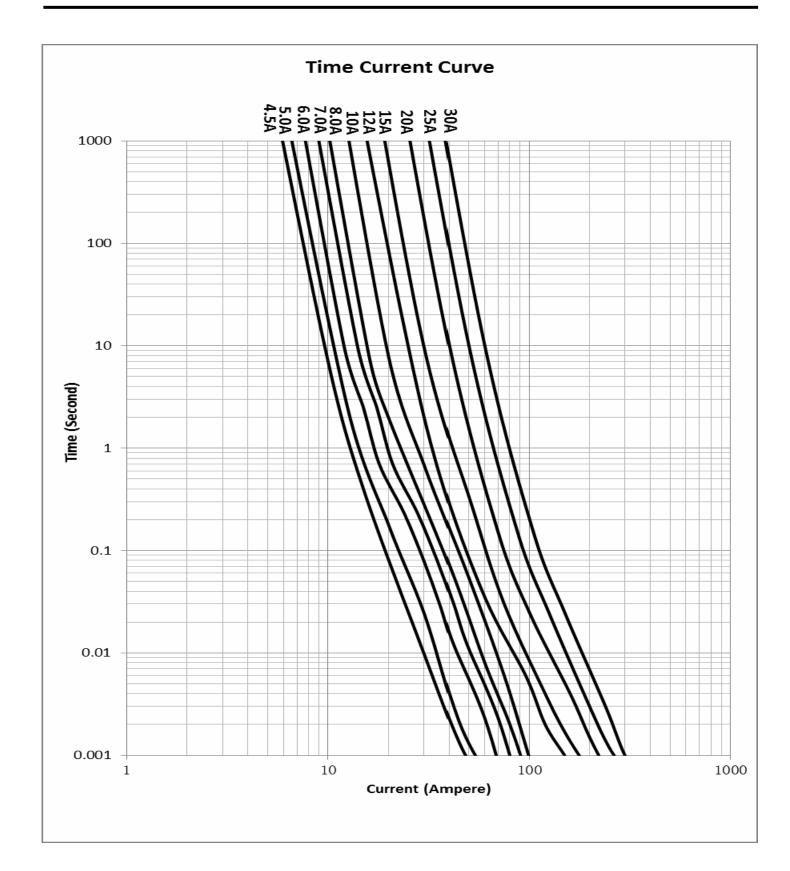
Unit: mm(inch)



















# **Soldering method**

Wave solder

■ Reservoir temperature: 260°C

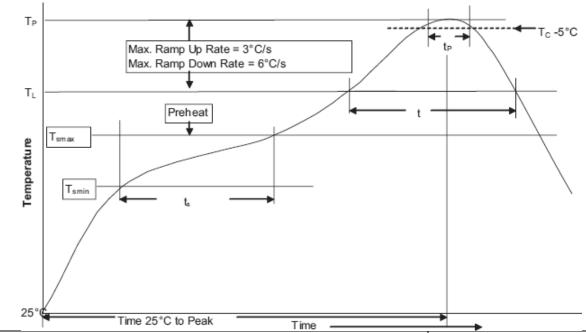
■ Time in reservoir: 10 seconds maximum

> Infrared reflow

■ Temperature: 260°C

■ Time: 30 seconds maximum

## Solder reflow profile



	Time			
Profile Feature		Lead(Pb) free solder		
Preheat and soak	Temperature min.(T <sub>smin</sub> )	150℃		
	Temperature max. (T <sub>smax</sub> )	200°C		
	<ul> <li>Time (T<sub>smin</sub> to T<sub>smax</sub>) (t<sub>S</sub>)</li> </ul>	60 - 120 Seconds		
Average ramp up rate T <sub>smax</sub> to	3°C / Second Max.			
Liquidous temperature (T <sub>L</sub> ) Time at liquidous (t <sub>L</sub> )	217°C 60 - 150 Seconds			
Peak package body temperat	260°C			
Time (t <sub>P</sub> ) within 5°C of the spe	30 Seconds			
Average ramp-down rate (T <sub>P</sub>	6°C / Second Max.			
Time (25°C to Peak Temperat	8 Minutes Max.			





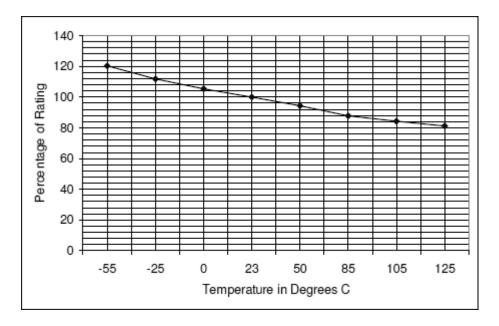




## **Temperature Derating Curve**

Normal ambient temperature: 23+/-3°C

Operating temperature: -55 ~ 125°C, with proper correction factor applied



# Package

3000 fuses on 8mm tape-and-reel on a 7 inch (178mm) reel per EIA Standard 481.

--- End of Document ---